

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs		User Part Number PESD9V0C1BSF Part Description										
								NXP ICN8 Protection INDI				
								BD package				
		Test		Test Conditions	Duration	# Lots	# Quantity	# Rejects				
			TEST									
	Pre- and Post-Stress											
# 1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below						
		MIL-STD-750-1										
	HTRB	M1038 Method A										
		Tj = Tjmax, Vr = 100% of max. datasheet										
# 5	Bias	reverse voltage	1000 hours	43	3440	0						
		150500 4404										
	TC Temperature Cycling	JESD22-A104 -40 °C to 125°C										
# 7	remperature Cycling		1000 cycles	67	5360	0						
		JESD22-A102										
	AC Autoclave	Tamb = 121 °C, RH = 100 %										
# 8	Autociave	Pressure = 205 kPa (29.7 psia)	96 hours	n.a.	n.a.	n.a.						
	HAST	JESD22-A110										
	Highly Accelerated Stress	Tamb = 130 °C, RH = 85%, VR = 80 % of										
# 9	Test	rated reverse voltage ^[1]	1000 hours	67	5360	0						
" 3		MIL-STD-750 Method 1037	1000 110010		5500							
	IOL	ton = toff, devices powered to insure ΔT_j =										
# 10	Intermittent Operating Life		1000 hours	n.a.	n.a.	n.a.						
	RSH	JESD22-A111										
# 20	Resistance to Solder Heat	260 °C ± 5 °C	10 s	n.a.	n.a.	n.a.						
	SD											
# 21	Solderability	J-STD-002		12	120	0						

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test # 5) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
NXP ICN8	Protection INDI	3440	0	1.2	8.10E+08

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